

# R1LV0216BSB

# 2Mb Advanced LPSRAM (128k word x 16bit)

R10DS0051EJ0100 Rev.1.00 2011.03.30

### **Description**

The R1LV0216BSB is a family of low voltage 2-Mbit static RAMs organized as 131,072-word by 16-bit, fabricated by Renesas's high-performance 0.15um CMOS and TFT technologies. The R1LV0216BSB has realized higher density, higher performance and low power consumption. The R1LV0216BSB is suitable for memory applications where a simple interfacing, battery operating and battery backup are the important design objectives. The R1LV0216BSB has been packaged in 44-pin TSOP.

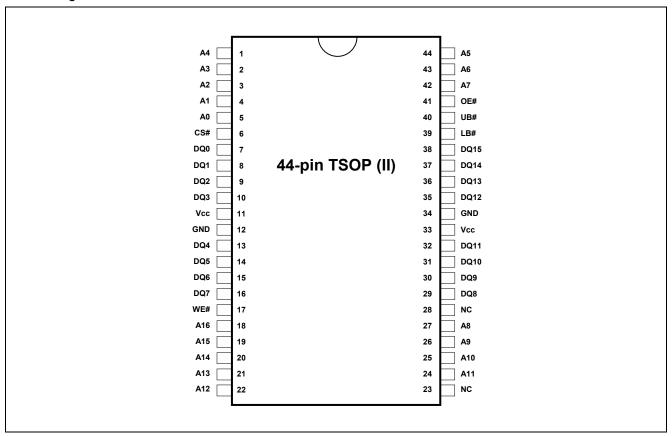
#### **Features**

- Single 2.7~3.6V power supply
- Small stand-by current: 1µA (3.0V, typical)
- No clocks, No refresh
- All inputs and outputs are TTL compatible.
- Easy memory expansion by CS#, LB# and UB#
- Common Data I/O
- Three-state outputs: OR-tie Capability
- OE# prevents data contention on the I/O bus

### **Ordering Information**

| Orderable Part Name | Access time | Temperature<br>Range | Package                            | Shipping<br>Container | Quantity               |
|---------------------|-------------|----------------------|------------------------------------|-----------------------|------------------------|
| R1LV0216BSB-5SR#B0  | 55 ns       | 0 ~ +70°C            |                                    |                       |                        |
| R1LV0216BSB-5SI#B0  | 55 115      | -40 ~ +85°C          |                                    | Trov                  | Max. 135pcs/Tray       |
| R1LV0216BSB-7SR#B0  | 70 ns       | 0 ~ +70°C            | 400-mil 44pin plastic<br>TSOP (II) | Tray                  | Max. 1080pcs/Inner Box |
| R1LV0216BSB-7SI#B0  | 70 118      | -40 ~ +85°C          | (normal-bend type)                 |                       |                        |
| R1LV0216BSB-5SR#S0  | 55 ns       | 0 ~ +70°C            |                                    |                       |                        |
| R1LV0216BSB-5SI#S0  | 55 118      | -40 ~ +85°C          | PTSB0044GD-B<br>(44P3F-B)          | Embossed              | 1000non/Pool           |
| R1LV0216BSB-7SR#S0  | 70 ns       | 0 ~ +70°C            | ,                                  | tape                  | 1000pcs/Reel           |
| R1LV0216BSB-7SI#S0  | 70115       | -40 ~ +85°C          |                                    |                       |                        |

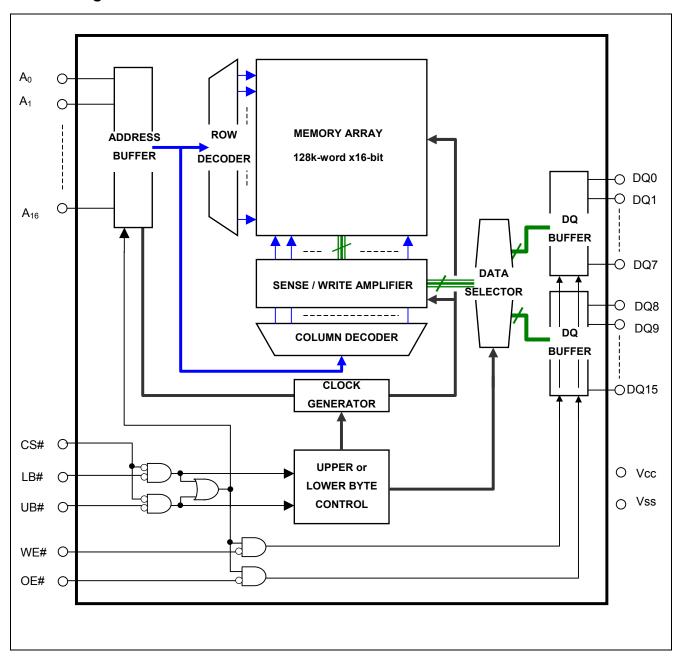
#### Pin Arrangement



### **Pin Description**

| Pin name    | Function          |
|-------------|-------------------|
| Vcc         | Power supply      |
| Vss         | Ground            |
| A0 to A16   | Address input     |
| DQ0 to DQ15 | Data input/output |
| CS#         | Chip select 1     |
| WE#         | Write enable      |
| OE#         | Output enable     |
| LB#         | Lower byte enable |
| UB#         | Upper byte enalbe |
| NC          | Non connection    |

### **Block Diagram**



### **Operation Table**

| CS# | LB# | UB# | WE# | OE# | DQ0~7  | DQ8~15 | Operation           |
|-----|-----|-----|-----|-----|--------|--------|---------------------|
| Н   | Χ   | Χ   | Χ   | Χ   | High-Z | High-Z | Stand-by            |
| Х   | Н   | Н   | Х   | Х   | High-Z | High-Z | Stand-by            |
| L   | L   | Н   | L   | Х   | Din    | High-Z | Write in lower byte |
| L   | L   | Н   | Н   | L   | Dout   | High-Z | Read in lower byte  |
| L   | L   | Н   | Н   | Н   | High-Z | High-Z | Output disable      |
| L   | Н   | L   | L   | Χ   | High-Z | Din    | Write in upper byte |
| L   | Н   | L   | Н   | L   | High-Z | Dout   | Read in upper byte  |
| L   | Н   | L   | Н   | Н   | High-Z | High-Z | Output disable      |
| L   | L   | L   | L   | Χ   | Din    | Din    | Word write          |
| L   | L   | L   | Н   | L   | Dout   | Dout   | Word read           |
| L   | L   | L   | Н   | Н   | High-Z | High-Z | Output disable      |

Note 1. H:  $V_{IH}$  L: $V_{IL}$  X:  $V_{IH}$  or  $V_{IL}$ 

### **Absolute Maximum**

| Parameter                                   | Symbol         | Va                      | lue                   | unit |
|---|----------------|-------------------------|-----------------------|------|
| Power supply voltage relative to Vss        | Vcc            | -0.5 to                 | V                     |      |
| Terminal voltage on any pin relative to Vss | $V_{T}$        | -0.5 <sup>*1</sup> to ' | Vcc+0.5 <sup>*2</sup> | V    |
| Power dissipation                           | P <sub>T</sub> | 0                       | .7                    | W    |
|   | Topr*3         | R Ver.                  | 0 to +70              | °C   |
| Operation temperature                       | ropr           | I Ver.                  | -40 to +85            |      |
| Storage temperature range Ts                |                | -65 to                  | o 150                 | °C   |
| Ctarana tamanaratura ranga undan hisa       | Tbias*3        | R Ver.                  | 0 to +70              | °C   |
| Storage temperature range under bias        | iblas          | I Ver.                  | -40 to +85            | ] (  |

Note 1. -3.0V for pulse  $\leq 30$ ns (full width at half maximum)

- 2. Maximum voltage is +4.6V.
- 3. Ambient temperature range depends on R/I-version. Please see table on page 1.

### **DC Operating Conditions**

| Parameter                 | Parameter          |          | Min. | Тур. | Max.    | Unit | Note |
|---------------------------|--------------------|----------|------|------|---------|------|------|
| Supply voltage            |                    | Vcc      | 2.7  | 3.0  | 3.6     | V    |      |
|                           |                    | Vss      | 0    | 0    | 0       | V    |      |
| Input high voltage        | Input high voltage |          | 2.2  | -    | Vcc+0.3 | V    |      |
| Input low voltage         |                    | $V_{IL}$ | -0.3 | -    | 0.6     | V    | 1    |
| Ambient temperature range | R Ver.             | Та       | 0    | -    | +70     | °C   | 2    |
| Ambient temperature range | I Ver.             |          | -40  | -    | +85     | °C   | 2    |

Note 1. -3.0V for pulse  $\leq 30$ ns (full width at half maximum)

### **DC Characteristics**

| Parameter                 | Symbol           | Min.         | Тур.            | Max. | Unit |                         | Test conditions   |  |  |  |
|---------------------------|------------------|--------------|-----------------|------|------|-------------------------|---|--|--|--|
| Input leakage current     | I <sub>LI</sub>  | -            | 1               | 1    | μΑ   | Vin = Vss t             | Vin = Vss to Vcc  |  |  |  |
| Output leakage current    | I <sub>LO</sub>  | -            | -               | 1    | μА   |                         | CS# = LB# = UB# = V <sub>IH</sub> or OE# =V <sub>IH</sub> ,<br>VI/O =Vss to Vcc   |  |  |  |
| Average operating current | I <sub>CC1</sub> | -            | 15              | 25   | mA   | Min. cycle,             | Min. cycle, duty =100%, $II/O = 0mA$<br>$CS\# = V_{IL}$ , Others = $V_{IH}/V_{IL}$  |  |  |  |
|                           | I <sub>CC2</sub> | -            | 2               | 5    | mA   | CS# ≤ 0.2\              | Cycle =1 $\mu$ s, duty =100%, II/O = 0mA<br>CS# $\leq$ 0.2V,<br>V <sub>IH</sub> $\geq$ Vcc-0.2V, V <sub>IL</sub> $\leq$ 0.2V                            |  |  |  |
| Standby current           | I <sub>SB</sub>  | -            | 1               | 0.5  | mA   | ` '                     | (1) CS# = V <sub>IH</sub> , Others = V <sub>IH</sub> /V <sub>IL</sub> or<br>(2) LB# = UB# = V <sub>IH</sub> , Others = V <sub>IH</sub> /V <sub>IL</sub> |  |  |  |
| Standby current           |                  | -            | 1 <sup>*1</sup> | 2    | μΑ   | ~+25°C                  | Vin = Vss to Vcc  |  |  |  |
|                           | ı                | -            | -               | 3    | μΑ   | ~+40°C                  | (1) CS# ≥ Vcc-0.2V or   |  |  |  |
|                           | I <sub>SB1</sub> | -            | -               | 8    | μΑ   | ~+70°C                  | (2) LB# = UB# ≥ Vcc-0.2V,<br>CS# ≤ 0.2V   |  |  |  |
|                           |                  | -            | -               | 10   | μΑ   | ~+85°C                  |   |  |  |  |
| Output high voltage       | V <sub>OH</sub>  | 2.4          | -               | -    | V    | I <sub>OH</sub> = -0.5m | ıA  |  |  |  |
|                           | $V_{\text{OH2}}$ | Vcc<br>- 0.5 |                 |      | V    | I <sub>OH</sub> = -0.05 | mA  |  |  |  |
| Output low voltage        | $V_{OL}$         | -            | -               | 0.4  | V    | I <sub>OL</sub> = 2mA   |   |  |  |  |

Note 1. Typical parameter indicates the value for the center of distribution at 3.0V (Ta= 25°C), and not 100% tested.

<sup>2.</sup> Ambient temperature range depends on R/I-version. Please see table on page 1.

### Capacitance

$$(Vcc = 2.7V \sim 3.6V, f = 1MHz, Ta = 0 \sim +70^{\circ}C / -40 \sim +85^{\circ}C^{*2})$$

| Parameter                  | Symbol           | Min. | Тур. | Max. | Unit | Test conditions | Note |
|----------------------------|------------------|------|------|------|------|-----------------|------|
| Input capacitance          | C in             | -    | -    | 8    | pF   | Vin =0V         | 1    |
| Input / output capacitance | C <sub>I/O</sub> | -    | -    | 10   | pF   | VI/O =0V        | 1    |

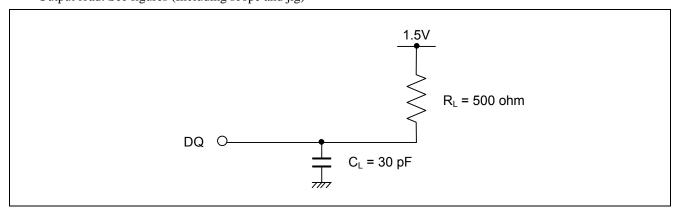
Note 1. This parameter is sampled and not 100% tested.

2. Ambient temperature range depends on R/I-version. Please see table on page 1.

#### **AC Characteristics**

Test Conditions (Vcc = 2.7V ~ 3.6V, Ta =  $0 \sim +70^{\circ}\text{C} / -40 \sim +85^{\circ}\text{C}^{*1}$ )

- Input pulse levels: VIL = 0.4V, VIH = 2.4V
- Input rise and fall time: 5ns
- Input and output timing reference level: 1.5V
- Output load: See figures (Including scope and jig)



Note 1. Ambient temperature range depends on R/I-version. Please see table on page 1.

### **Read Cycle**

| Parameter                                  | Cumbal           | R1LV021 | 6BSB-5S* | R1LV021 | 6BSB-7S* | Unit  | Note  |
|--|------------------|---------|----------|---------|----------|-------|-------|
| Farameter                                  | Symbol           | Min.    | Max.     | Min.    | Max.     | Offic | Note  |
| Read cycle time                            | t <sub>RC</sub>  | 55      | -        | 70      | -        | ns    |       |
| Address access time                        | t <sub>AA</sub>  | -       | 55       | -       | 70       | ns    |       |
| Chip select access time                    | t <sub>ACS</sub> | -       | 55       | -       | 70       | ns    |       |
| Output enable to output valid              | toE              | -       | 30       | -       | 35       | ns    |       |
| Output hold from address change            | t <sub>OH</sub>  | 10      | -        | 10      | -        | ns    |       |
| LB#, UB# access time                       | t <sub>BA</sub>  | -       | 55       | -       | 70       | ns    |       |
| Chip select to output in low-Z             | t <sub>CLZ</sub> | 10      | -        | 10      | -        | ns    | 2,3   |
| LB#, UB# enable to low-Z                   | t <sub>BLZ</sub> | 10      | -        | 10      | -        | ns    | 2,3   |
| Output enable to output in low-Z           | toLZ             | 5       | -        | 5       | -        | ns    | 2,3   |
| Chip deselect to output in high-Z          | t <sub>CHZ</sub> | 0       | 20       | 0       | 25       | ns    | 1,2,3 |
| LB#, UB# disable to high-Z t <sub>B+</sub> |                  | 0       | 20       | 0       | 25       | ns    | 1,2,3 |
| Output disable to output in high-Z         | t <sub>OHZ</sub> | 0       | 20       | 0       | 25       | ns    | 1,2,3 |

#### **Write Cycle**

| Parameter                          | Symbol           | Symbol R1LV0216BSB-5S* |      | R1LV021 | 6BSB-7S* | Unit  | Note |
|------------------------------------|------------------|------------------------|------|---------|----------|-------|------|
| Faiailletei                        | Symbol           | Min.                   | Max. | Min.    | Max.     | Offic | NOLE |
| Write cycle time                   | twc              | 55                     | -    | 70      | -        | ns    |      |
| Address valid to end of write      | t <sub>AW</sub>  | 50                     | -    | 55      | -        | ns    |      |
| Chip select to end of write        | t <sub>CW</sub>  | 50                     | -    | 55      | -        | ns    | 5    |
| Write pulse width                  | t <sub>WP</sub>  | 45                     | -    | 50      | -        | ns    | 4    |
| LB#, UB# valid to end of write     | t <sub>BW</sub>  | 50                     | -    | 55      | -        | ns    |      |
| Address setup time                 | t <sub>AS</sub>  | 0                      | -    | 0       | -        | ns    | 6    |
| Write recovery time                | t <sub>WR</sub>  | 0                      | -    | 0       | -        | ns    | 7    |
| Data to write time overlap         | t <sub>DW</sub>  | 25                     | -    | 30      | -        | ns    |      |
| Data hold from write time          | t <sub>DH</sub>  |                        | -    | 0       | -        | ns    |      |
| Output enable from end of write    | tow              | 5                      | -    | 5       | -        | ns    | 2    |
| Output disable to output in high-Z | t <sub>OHZ</sub> | 0                      | 20   | 0       | 25       | ns    | 1,2  |
| Write to output in high-Z          | t <sub>WHZ</sub> | 0                      | 20   | 0       | 25       | ns    | 1,2  |

Note

- 1. t<sub>CHZ</sub>, t<sub>OHZ</sub> and t<sub>WHZ</sub> are defined as the time at which the outputs achieve the open circuit conditions and are not referred to output voltage levels.
- 2. This parameter is sampled and not 100% tested.
- 3. At any given temperature and voltage condition,  $t_{HZ}$  max is less than  $t_{LZ}$  min both for a given device and from device to device.
- 4. A write occurs during the overlap of a low CS#, a low WE# and a low LB# or a low UB#.

A write begins at the latest transition among CS# going low, WE# going low and LB# going low or UB# going low.

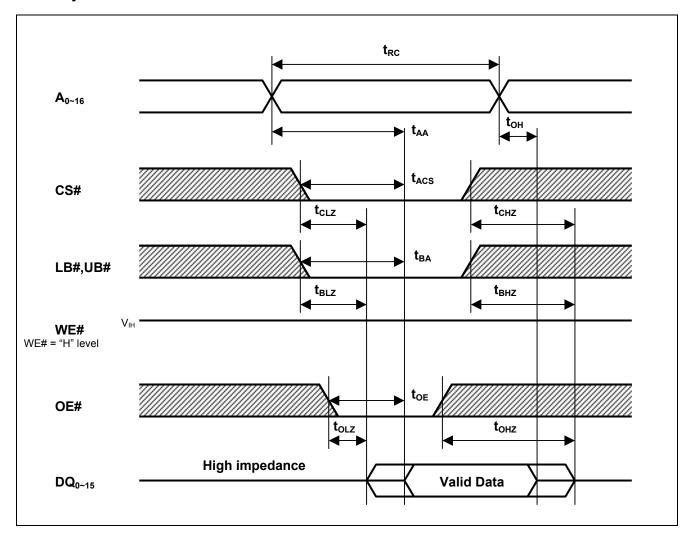
A write ends at the earliest transition among CS# going high, WE# going high and LB# going high or UB# going high.

 $t_{\text{WP}}$  is measured from the beginning of write to the end of write.

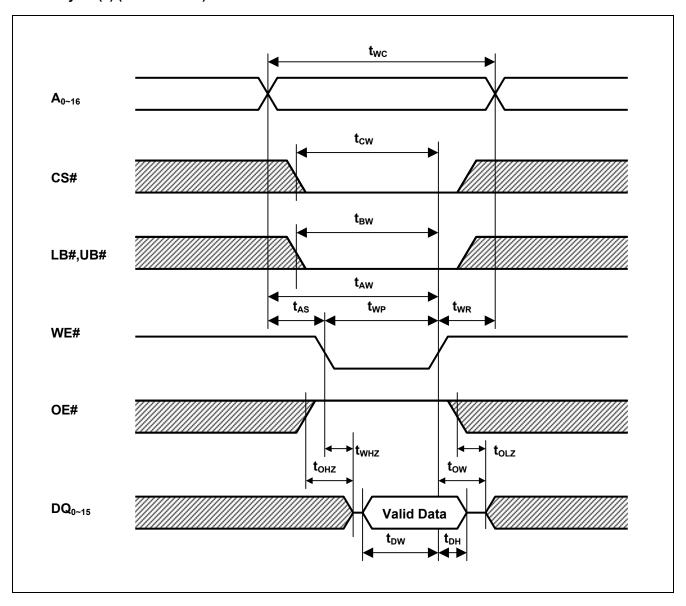
- 5.  $t_{CW}$  is measured from the later of CS# going low to end of write.
- 6.  $t_{\text{AS}}$  is measured the address valid to the beginning of write.
- 7.  $t_{WR}$  is measured from the earliest of CS#, WE#, LB# or UB# going high to the end of write cycle.
- 8. Don't apply inverted phase signal externally when DQ pin is output mode.

## **Timing Waveforms**

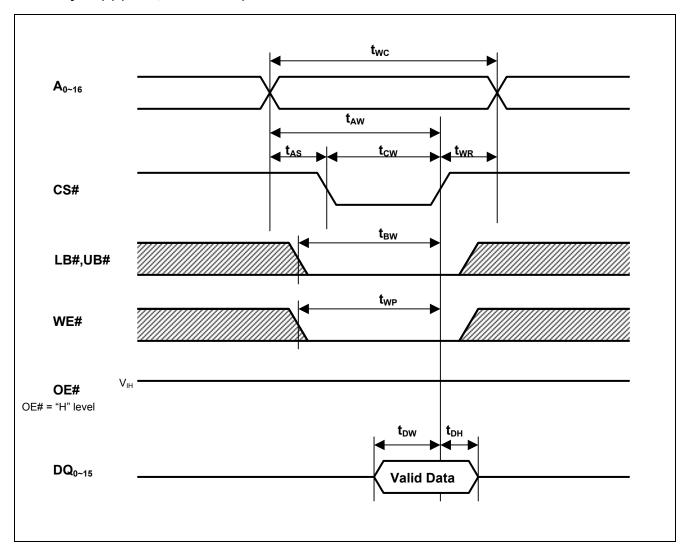
### **Read Cycle**



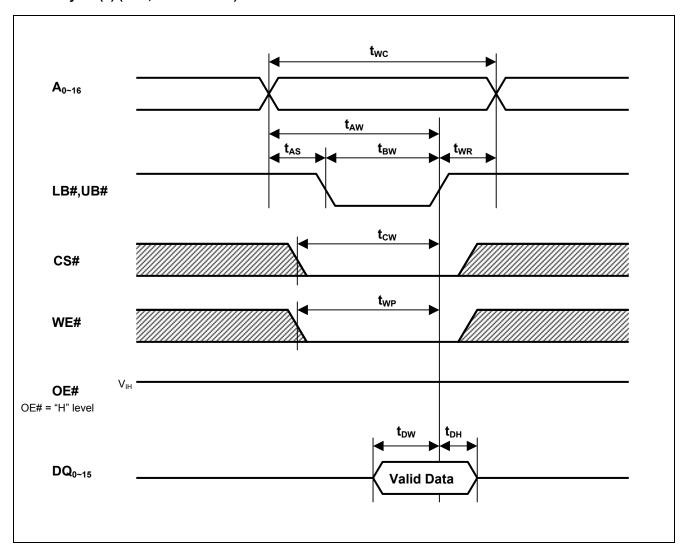
## Write Cycle (1) (WE# CLOCK)



### Write Cycle (2) (CS1#, CS2 CLOCK)



### Write Cycle (3) (LB#, UB# CLOCK)



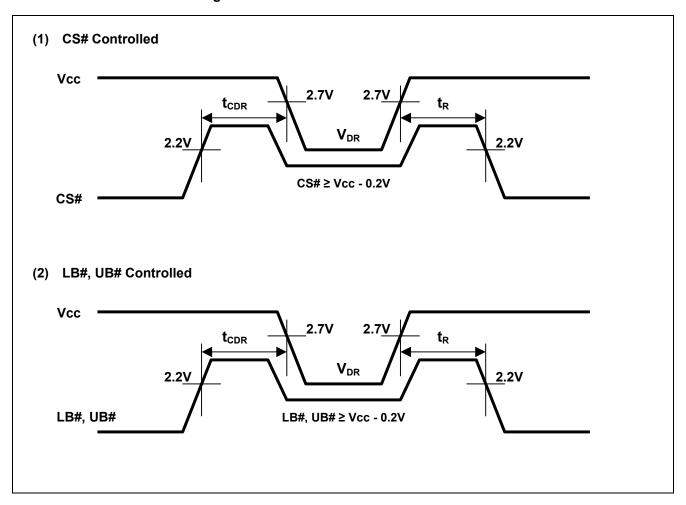
#### Low Vcc Data Retention Characteristics

| Parameter                            | Symbol            | Min. | Тур.            | Max. | Unit |  | Test conditions <sup>*2</sup>           |  |
|--------------------------------------|-------------------|------|-----------------|------|------|--|---|--|
| V <sub>CC</sub> for data retention   | $V_{DR}$          | 2.0  | -               | 3.6  | ٧    | Vin ≥ 0V<br>(1) CS# ≥ Vcc-0.2V or<br>(2) LB# = UB# ≥ Vcc-0.2V,<br>CS# ≤ 0.2V |   |  |
|                                      |                   | -    | 1 <sup>*1</sup> | 2    | μΑ   | ~+25°C   | Vcc=3.0V, Vin ≥ 0V                      |  |
| Data retention current               | I <sub>CCDR</sub> | -    | -               | 3    | μΑ   | ~+40°C   | (1) CS# ≥ Vcc-0.2V or                   |  |
| Data retention current               |                   | -    | -               | 8    | μΑ   | ~+70°C   | (2) LB# = UB# ≥ Vcc-0.2V,<br>CS# ≤ 0.2V |  |
|                                      |                   | -    | -               | 10   | μΑ   | ~+85°C   |   |  |
| Chip deselect to data retention time | t <sub>CDR</sub>  | 0    | -               | -    | ns   | See retention waveform.  |   |  |
| Operation recovery time              | t <sub>R</sub>    | 5    | _               | _    | ms   |  |   |  |

Note 1. Typical parameter indicates the value for the center of distribution at 3.0V (Ta= 25°C), and not 100% tested.

<sup>2.</sup> CS# controls address buffer, WE# buffer, OE# buffer, LB# buffer, UB# buffer and Din buffer. If CS# controls data retention mode, Vin levels (address, WE#, OE#, LB#, UB#, DQ) can be in the high impedance state.

### **Low Vcc Data Retention Timing Waveforms**



| Revision History | R1LV0216BSB Data Sheet |
|------------------|------------------------|
|------------------|------------------------|

|      |            |      | Description          |  |  |  |  |
|------|------------|------|----------------------|--|--|--|--|
| Rev. | Date       | Page | Summary              |  |  |  |  |
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